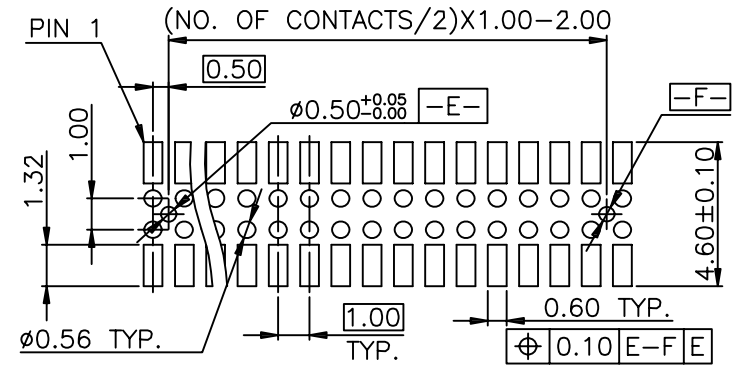
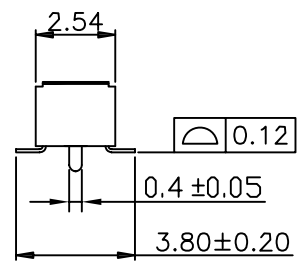
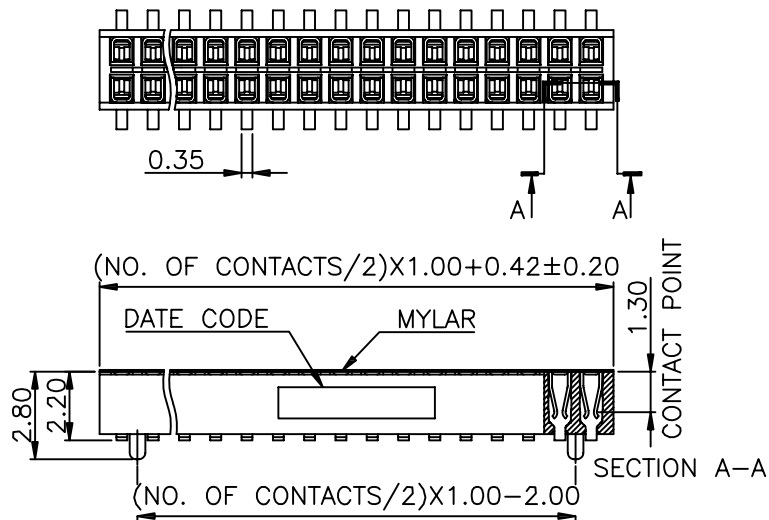
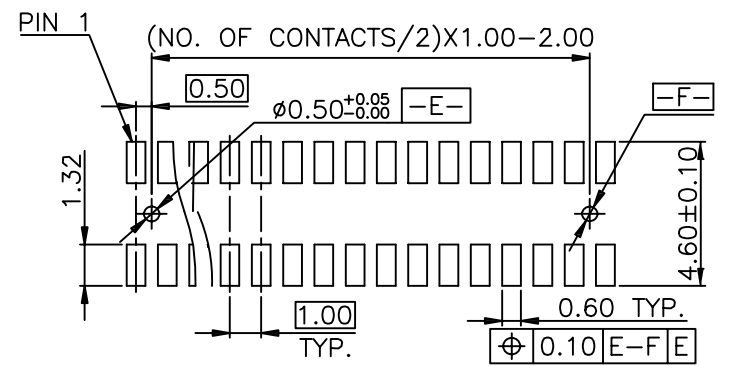


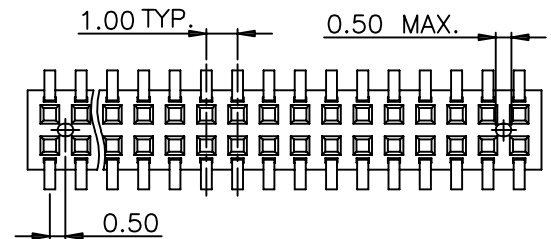
REV.	DESCRIPTION	DATE	DWN	APVD
A	RELEASED	20MAY09	MD	DZ



RECOMMEND PCB LAYOUT FOR BOTTOM ENTRY
PCB TOLERANCE:±0.05



RECOMMEND PCB LAYOUT FOR TOP ENTRY
PCB TOLERANCE:±0.05



NOTE:

- MATERIAL:
HOUSING: LCP, UL 94V-0, BLACK COLOR.
CONTACTS: PHOSPHOR BRONZE.
MYLAR: PI.
- FINISH:
CONTACTS: (SEE TABLE) GOLD PLATED ON CONTACT AREA, 2.54μm [100μ"] MIN. MATTE-TIN ON SOLDER TAIL, WITH ENTIRE CONTACT UNDERPLATED 1.27μm [50μ"] MIN. NICKEL.

TAPE & REEL	70	0.0762μm [3μ"]	J13-0001-02
		0.0254μm [1μ"]	J13-0001-01
PACKAGE	PIN NO.	MIN. GOLD THICKNESS	PART NUMBER

TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ± - 1 PLC ± 0.3 2 PLC ± 0.2 3 PLC ± 0.15 4 PLC ± - ANGLES ± 3°		DWN MICHAEL_DONG 23June2009 CHK GAVIN_CHEN 23June2009 APVD DAVID_ZHONG 23June2009	Zhongxiang Electron Science CO.,LTD	
MATERIAL SEE NOTE		APPLICATION SPEC	NAME	
FINISH SEE NOTE		WEIGHT	SOCKET 1.00mmx1.00mm D/R W/P SMT T(B)/E W/MYLAR	
PROJECTION		DIMENSIONS: MM	SIZE A3	DRAWING NO. J-13-0001
CUSTOMER DRAWING		SCALE -	SHEET 1 of 1	REV A